TOSHIBA THYRISTOR SILICON PLANAR TYPE

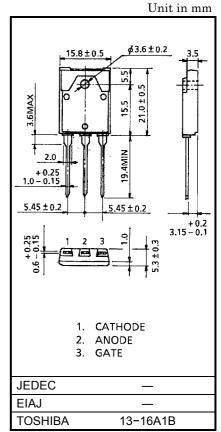
SF25GZ51,SF25JZ51

MEDIUM POWER CONTROL APPLICATIONS

MAXIMUM RATINGS

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	SF25GZ51	V_{DRM}	400		
	SF25JZ51	V _{RRM}	600	V	
Non-Repetitive Peak Reverse Voltage (Non-Repetitive < 5 ms, $T_j = 0 \sim 125$ °C)	SF25GZ51	V	500	V	
	SF25JZ51	V_{RSM}	720	V	
Average On-State Current (Half Sine Waveform)		I _{T (AV)}	25	Α	
R.M.S On-State Current	I _{T (RMS)}	39	Α		
Peak One Cycle Surge On-State Current (Non-Repetitive)		I _{TSM}	350 (50 Hz)	Α	
			385 (60 Hz)		
I ² t Limit Value	I ² t	612	A ² s		
Critical Rate of Rise of On Current	di / dt	100	A / μs		
Peak Gate Power Dissipat	P _{GM}	5	W		
Average Gate Power Dissi	P _{G (AV)}	0.5	W		
Peak Forward Gate Voltag	V_{FGM}	10	V		
Peak Reverse Gate Voltag	V_{RGM}	-5	V		
Peak Forward Gate Currer	I _{GM}	2	Α		
Junction Temperature	Tj	-40 ~ 125	°C		
Storage Temperature Ran	T _{stg}	-40 ~ 125	°C		
Isolation Voltage (AC, t = 1	V _{Isol}	1500	V		

Note : di / dt Test Condition, i_G = 30mA, t_{gw} = 10 $\mu s,\,t_{gr} \leq$ 250ns



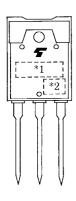
Weight: 5.9g



ELECTRICAL CHARACTERISTICS (Ta = 25°C)

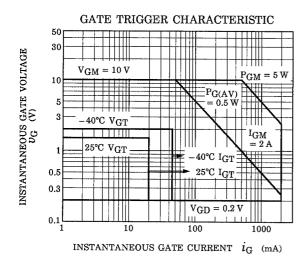
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	I _{DRM} I _{RRM}	V _{DRM} = V _{RRM} = Rated	_	_	20	μΑ
Peak On-State Voltage	V_{TM}	I _{TM} = 80 A	_	_	1.5	V
Gate Trigger Voltage	V_{GT}	V _D = 6 V, R _I = 10 Ω	_	_	1.5	V
Gate Trigger Current	I _{GT}	VD - 0 V, KL - 10 22	_	_	20	mA
Holding Current	lΗ	V _D = 6 V, I _{TM} = 500 mA	_	_	100	mA
Critical Rate of Rise of Off-State Voltage	dv / dt	V _{DRM} = Rated, Tc = 125°C Exponential Rise	_	50	_	V / µs
Thermal Resistance	R _{th (j-c)}	Junction to Case	_	_	1.3	°C/W

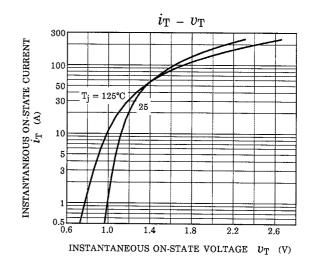
MARKING

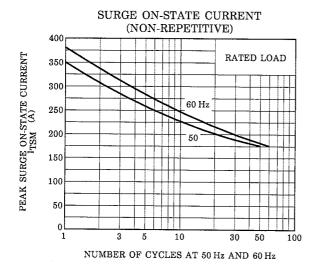


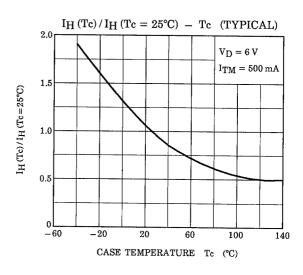
NUMBER	SYMBOL		MARK
*1	TYPE	SF25GZ51	F25GZ51
		SF25JZ51	F25JZ51
*2		Starting from Alphabet A ast Decimal Digit of ne Year of Manufacture	Example 8A : January 1998 8B : February 1998 8L : December 1998

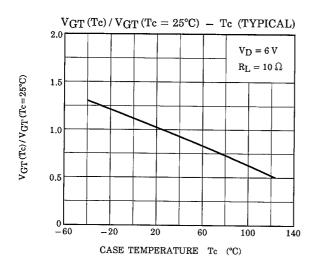
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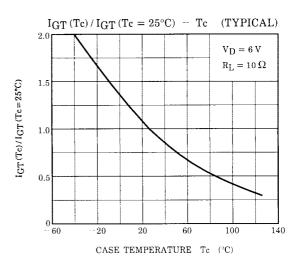


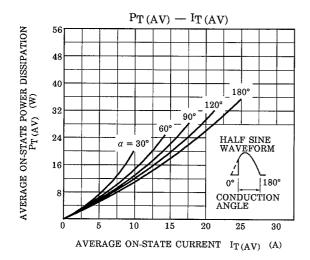


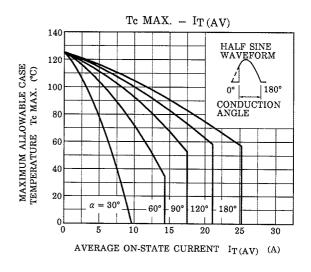


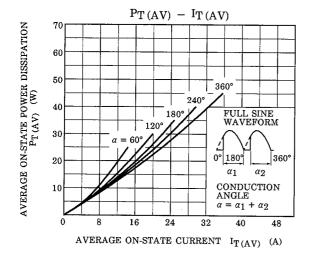


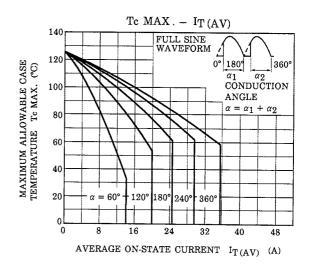


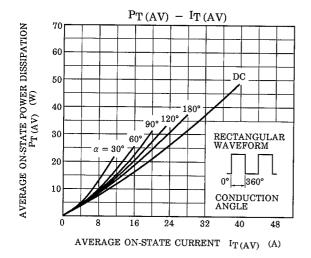


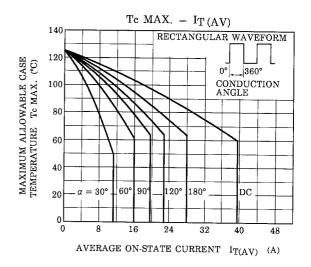




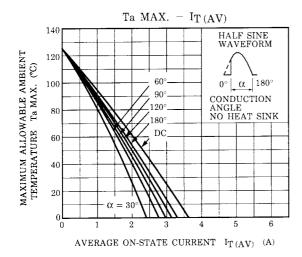


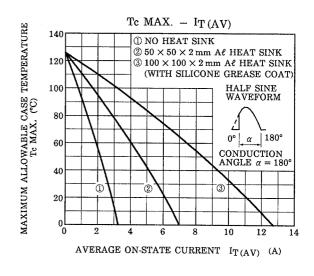


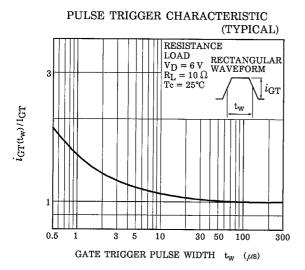


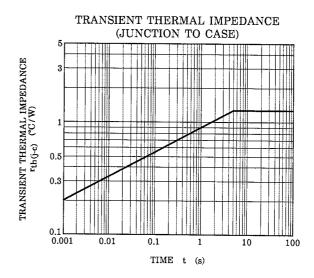


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